

MECHANICAL ENGINEERING & SCIENCE POSTGRADUATE INTERNATIONAL CONFERENCE 2021

13th MARCH 2021

CALL FOR PAPER

MESPIC'21 is intended to provide a technical forum and workshops among the mechanical engineering postgraduate students. It is a good platform to show research findings, and share ideas, developments and applications related to various aspects of engineering research areas.

EARLY BIRD FEES

by 21st January 2021

Participant Category	Local	International
Presenter	RM 1300	USD 350
Non-presenter & delegates	RM 50	USD 20
Additional paper	RM 1100 / paper (max 2 papers)	USD 300

NORMAL FEES

by 19th February 2021

Participant Category	Local	International
Presenter	RM 1400	USD 400
Non-presenter & delegates	RM 50	USD 20
Additional paper	RM 1100 / paper (max 2 papers)	USD 300

IMPORTANT DATES

Submission of Manuscript : 27th November 2020
Completion of Review : 7th January 2021
Notification of Acceptance : 14th January 2021
Revised Final Manuscript : 7th February 2021

PAYMENT METHOD

Bank Name : Bank Islam Malaysia Berhad
City / State of Bank : Shah Alam, Selangor
Beneficiary name : Bendahari UiTM
Account no : 12177010005704
SWIFT Code : BIMBMYKL
Payment Reference : WCOSSET2021 FKM (220801060001)

Note: The conference fee is NOT inclusive of any incurring bank or telegraphic transfer fees, which is to be paid by the participants.

SCOPE OF INTEREST

1. Green Energy and Environment

Energy Systems: Analysis, Thermodynamics and Sustainability
Energy Management & Policy
Energy Audit
Combustion
High Efficiency Engines
Renewable & Alternative Energy
Waste Energy Recovery

2. Mechanics of Solids and Structure Integrity

Finite Element Modelling & Analysis
Impact Analysis
Fatigue & Fracture Mechanics

3. Advances in Material Science and Processing

Micro & Nano Systems
Advanced Metallurgy
Composite & Ceramics
Metal Alloy
Polymeric Processing
Corrosion & Coating
Micro Electro-Mechanical Systems

4. Dynamics, Control and System Engineering

Intelligent Systems and Information Technology
Sensor Technology
Sound & Vibration Design
Robotics, Computing and Computer Engineering
Mechatronics Systems
Electro-Mechanical Systems

5. Bioengineering and Clinical Engineering

PUBLICATIONS



Selected papers will be published in a SCOPUS indexed journal:

**Solid State
Technology
Journal**

(ISSN: 0038-111X)

CONTACT US

Secretariat MESPIC 2021

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BEST PAPER AND PRESENTER AWARDS

E-certificates will be provided to all participants